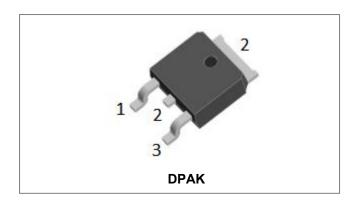


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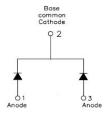
# **6CWQ15FN SCHOTTKY RECTIFIER**



#### **Features**

- 150°C T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- · Additional testing can be offered upon request

## **Circuit Diagram**



### **Applications**

- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

# **Maximum Ratings:**

Characteristics	Symbol	Condition Max.		Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	150	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	50% duty cycle @T <sub>C</sub> = 131°C, rectangular wave form	3.5(Peg Leg) 7(Peg Device)	Α
Peak One Cycle Non-Repetitive Surge Current(Peg Leg)	I <sub>FSM</sub>	8.3 ms, half Sine pulse	84	Α

#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop	V <sub>F1</sub>	@ 3A, Pulse, T <sub>J</sub> = 25 °C	0.79	0.83	V
(Per Leg) *	$V_{F2}$	@ 3A, Pulse, T <sub>J</sub> = 125 °C	0.61	0.65	V
Reverse Current (per leg) *	I <sub>R1</sub>	$@V_R = \text{rated } V_{R, T_J} = 25  ^{\circ}\text{C}$	0.0001	1.00	mA
	I <sub>R2</sub>	$@V_R = \text{rated } V_{R,} T_J = 125  ^{\circ}\text{C}$	0.03	5	mA
Junction Capacitance(Per Leg)	Ст	$@V_R = 5V, T_C = 25  ^{\circ}C, f_{SIG} = 1MHz$		100	pF
Series Inductance (Per Leg)	Ls	Measured lead to lead 5 mm from package body	5.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

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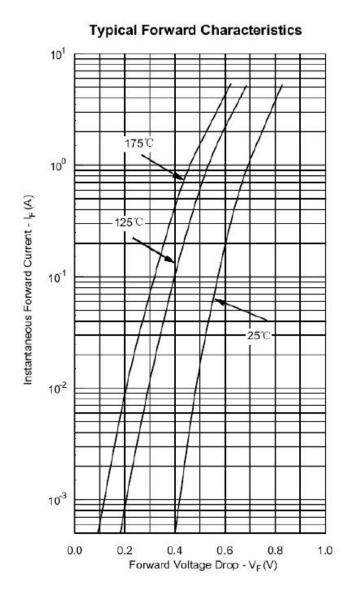




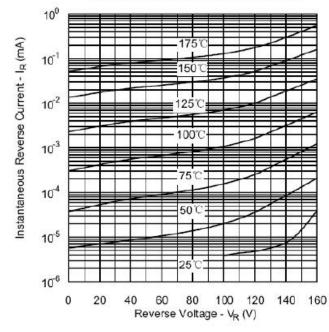
# **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Symbol Condition Specificati		Units
Junction Temperature	$T_J$	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to	R <sub>0JC</sub> -		4.7(peg leg)	°C/W
Case(Per Leg)			2.35(peg device)	
Approximate Weight	wt	-	0.39	g
Case Style	DPAK			

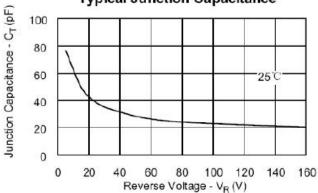
# **Ratings and Characteristics Curves**



### **Typical Reverse Characteristics**



## Typical Junction Capacitance



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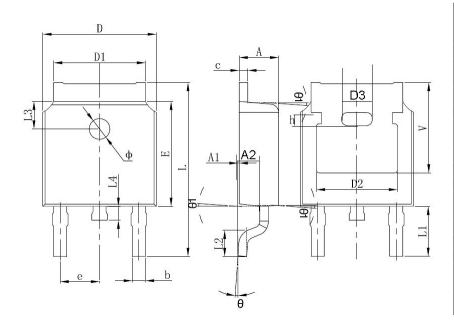


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#### **Mechanical Dimensions DPAK**



SYMBOL	Millimeters		Inches	
STIVIBUL	Min.	Max.	Min.	Max.
Α	2.20	2.40	0.087	0.094
A1	0.00	0.127	0.000	0.005
b	0.66	0.86	0.026	0.034
С	0.46	0.60	0.018	0.024
D	6.50	6.70	0.256	0.264
D1	5.13	5.46	0.202	0.215
D2	4.83 REF.		0.190 REF.	
Е	6.00	6.20	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.70	10.40	0.381	0.409
L1	2.90 REF.		0.144 REF.	
L2	1.40	1.70	0.055	0.067
L3	1.60 REF.		0.063 REF.	
L4	0.60	1.00	0.024	0.039
Ф	1.10	1.30	0.043	0.051
Θ	0°	8°	0°	8°
h	0.00	0.30	0.000	0.012
V	5.35 REF.		0.211	REF.

### **Ordering Information**

Device	Package	Shipping	
6CWQ15FN	DPAK (Pb-Free)	2500pcs / reel	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

# **Marking Diagram**



#### Where XXXXX is YYWWL

6 = Forward Current (7A)
CW = Configuration
Q = Device Type
15 = Reverse Voltage (150V)
FN = Package type
SSG = SSG

 SSG
 = SSG

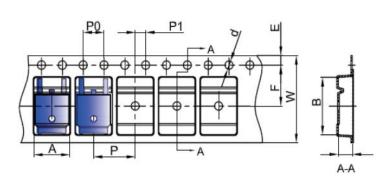
 YY
 = Year

 WW
 = Week

 L
 = Lot Number

Cautions: Molding resin Epoxy resin UL:94V-0

### **Carrier Tape Specification DPAK**



SYMBOL	Millimeters		
STWIBOL	Min.	Max.	
Α	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Ф1.45	Ф1.65	
Е	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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#### 6CWQ15FN



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